

**FIT Hon Teng Limited**  
鴻騰六零八八精密科技股份有限公司

# 1Q24 Results Announcement

二零二四年第一季度業績發佈會



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# Agenda

**1Q24 Financial Overview**

**2024 & 2Q24 Guidance**

**Execution Status Update**

**News Update**

**Q&A Section**



# Financial Highlight

## 1Q24 Financial Highlight

### REVENUE

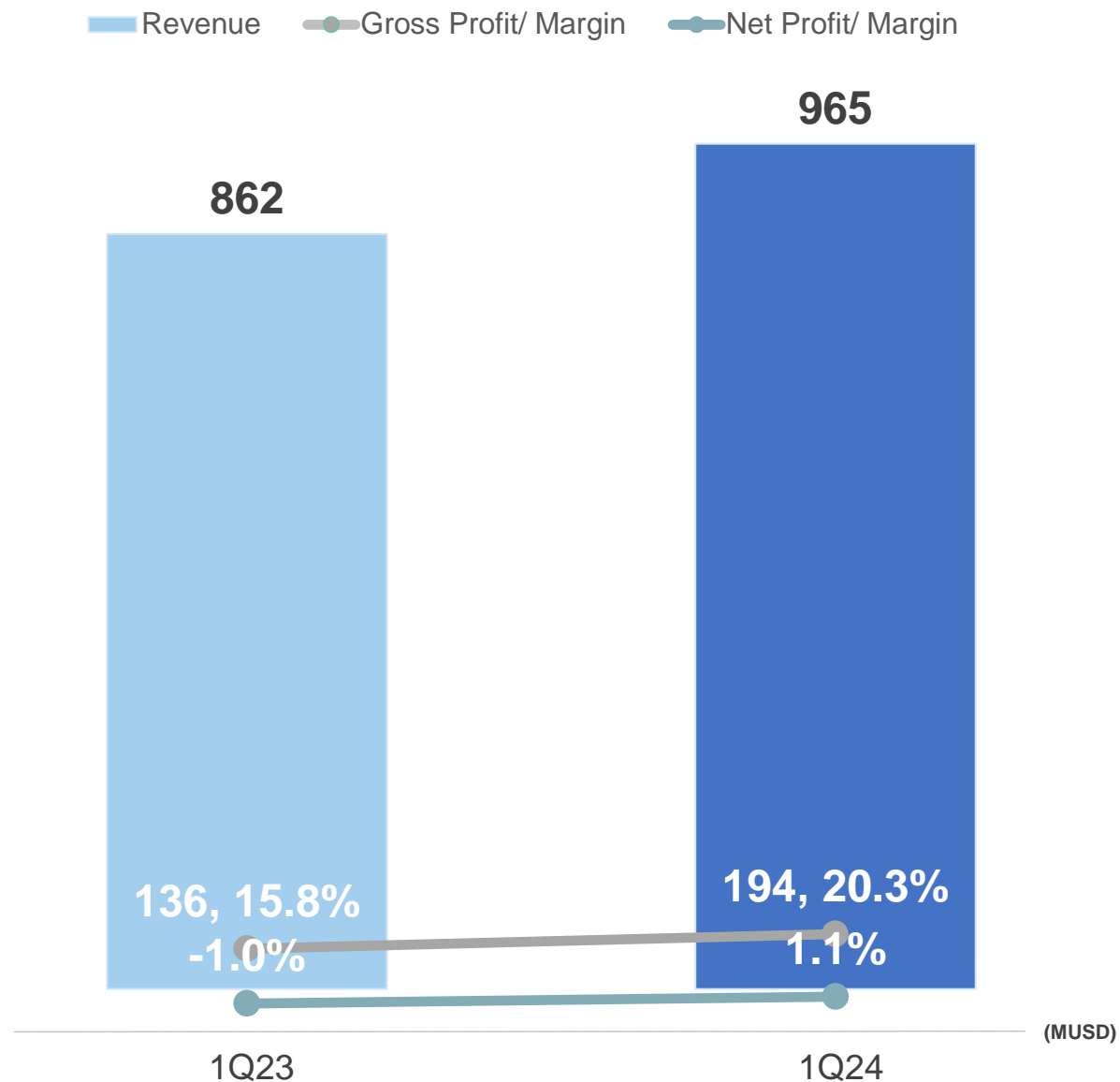
**+12%**

### GROSS PROFIT

**+44%**

### NET INCOME

**n.a.**

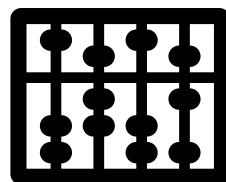




# Financial Guidance

# 2024 Full Year Financials Guidance

↑ > +15%    ↗ +5 – 15%    → 0 ± 5    ↘ -5 – 15%    ↓ < -15%



Revenue



Gross Profit



Operating Profit

YoY





> +15%  
 +5 – 15%  
 0 ± 5  
 -5 – 15%  
 < -15%

# 2024 & 2Q24 Guidance

	Smartphones	Networking	Computing	EV Mobility	System Products	Others
2024 YoY						
2Q24 YoY						

# Execution Status Updates

## 3+3 Execution Status Update



### EV Mobility

- Synergy created by FIT Voltaira



### New Generation 5G AIoT

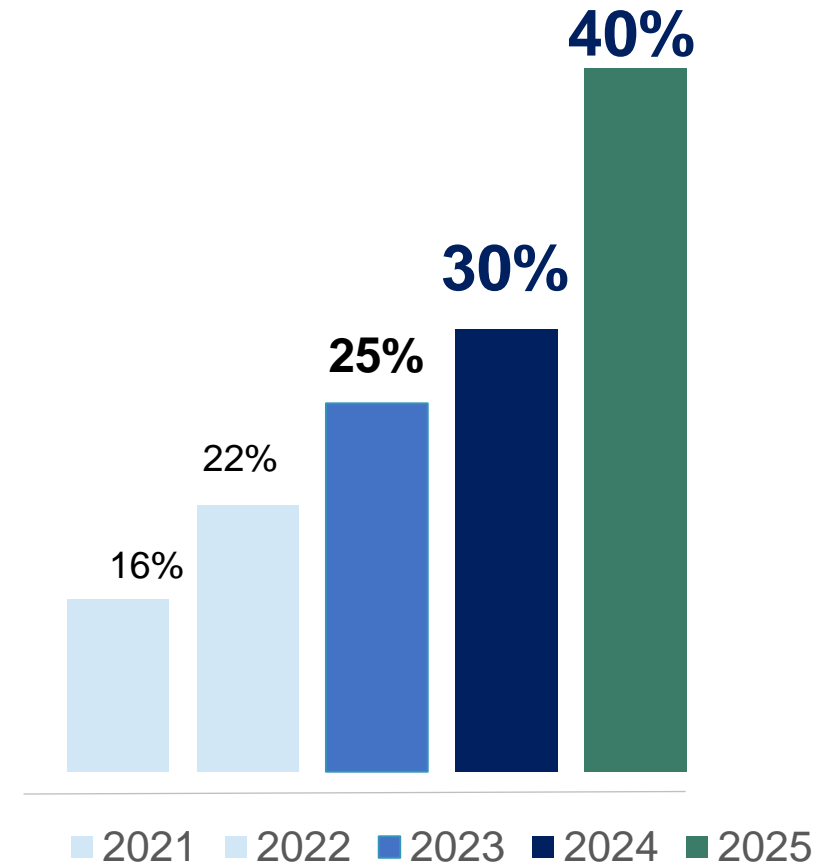
- MTK CPO Project
- AI Server Opportunity –
  - EDSFF connectors,
  - MCIO, MXIO, and DA CEM cable for PCIE 6.0
  - CAMM Socket for memory solution



### Audio

- Preparation of global service expansion

## Revenue Mix Forecast Update



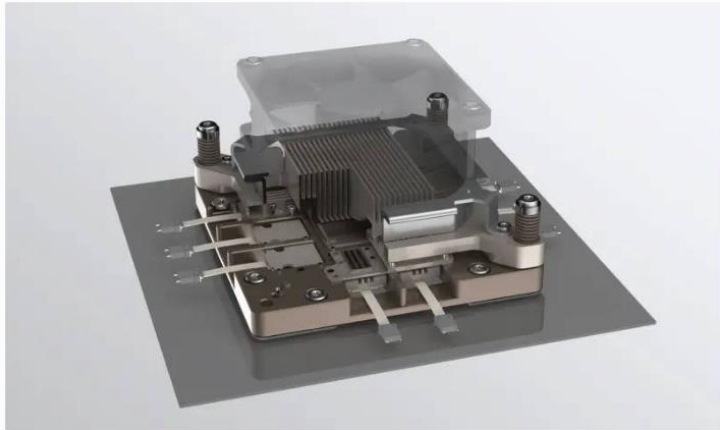
# News Updates

# Recent Announcements

## AI引爆大算力！鴻海旗下鴻騰攜手聯發科出擊

NOWnews 今日新聞  
更新於 03月25日10:21 • 發布於 03月25日10:21 • 記者許家楨 / 台北報導

追蹤



▲鴻海旗下鴻騰攜手聯發科技，以ASIC平台、矽光子技術共同開發CPO、高速連接解決方案。（圖 / 鴻騰提供）

[NOWnews今日新聞] AI生成式應用引爆大算力時代，鴻海旗下鴻騰（FIT）精密科技攜手聯發科技，以ASIC平台、矽光子技術共同開發CPO、高速連接解決方案。鴻騰先前就以「FITCONN」創新800G高速連接器，獲得德國紅點設計大獎，這次再接再厲，與聯發科技共同合作，聯發科技透過其ASIC平台並整合自主研發的高速SerDes以及矽光子技術，搭配FIT CPO產品、以及精密的ASIC SKT連接器，為交換機提供高效能運算系統。

25 March  
MTK CPO Project

## 鴻騰發布正面營利預告 首季淨利潤大勝去年同期

2024/04/15 21:09



鴻海旗下鴻騰今年首季淨利潤約介於700萬美元至1000萬美元，顯著優於去年同期表現，（鴻騰提供）

〔記者方壹傑 / 台北報導〕鴻海（2317）旗下鴻騰精密科技（FIT）董事會今天發布正面營利預告，今年首季淨利潤約介於700萬美元至1000萬美元（約新台幣2.26億元至3.24億美元），顯著優於去年同期的淨虧損900萬美元（約新台幣2.91億美元）。

15 April  
Profit Alert



# Q&A section



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Foxconn Interconnect Technology Limited (Incorporated in the Cayman Islands and carrying on business in Hong Kong as FIT Hon Teng Limited)

鴻騰精密科技股份有限公司 (於開曼群島成立，並以鴻騰六零八八精密科技股份有限公司於香港經營業務)

# Appendix

## Statement of Comprehensive Income

(M'USD)	1Q24	1Q23	YoY
Revenue	965	862	12%
Gross Profit	196	136	44%
Gross Profit Margin	20.3%	15.8%	+450bps
Opex	172	130	32%
<b>Operating Profit</b>	<b>24</b>	<b>6</b>	300%
Operating Profit Margin	2.5%	0.7%	+180bps
<b>Profit before Tax</b>	<b>20</b>	<b>(3)</b>	-767%
Income Tax Expense	(10)	(6)	67%
<b>Profit for the Year</b>	<b>10</b>	<b>(9)</b>	N/A
Profit Attributed to :			
Owners of the Company	10	(9)	N/A
Non-controlling Interests	0	0	N/A
<b>Basic EPS</b>	<b>0.14</b>	<b>(0.13)</b>	0.27

## Balance Sheet

(K'USD)	As of 31 Mar 2023	As of 31 Mar 2023	YoY
Cash and Cash equivalents	1,378,546	981,695	40%
Inventory	837,924	863,098	-3%
Receivables	676,556	604,110	12%
Other current assets	302,615	128,420	136%
Non-current assets	1,954,976	1,755,644	11%
<b>Total Assets</b>	<b>5,150,617</b>	<b>4,332,967</b>	19%
Current Liabilities	(2,071,123)	(1,911,162)	8%
Non-Current Liabilities	(688,950)	(63,772)	980%
<b>Total Liabilities</b>	<b>(2,760,073)</b>	<b>(1,974,934)</b>	40%
<b>Equity</b>	<b>2,390,544</b>	<b>2,358,033</b>	1%